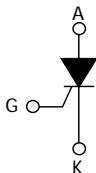
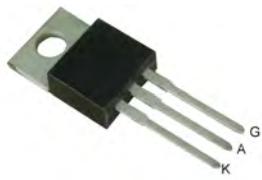
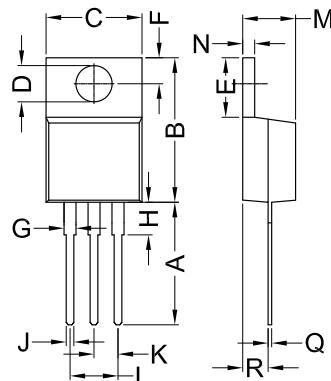


STYN212(S) thru STYN1012(S)

Thyristor Discretes(SCRs)

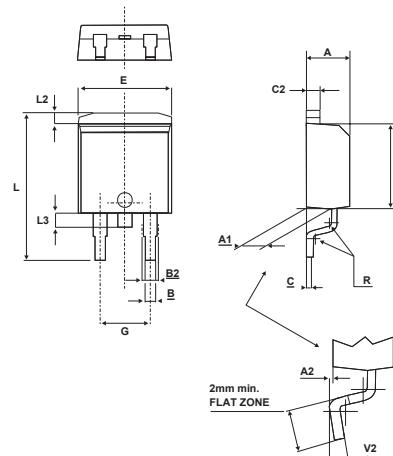


Dimensions TO-220AB



REF.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	12.70	13.97	0.500	0.550
B	14.73	16.00	0.580	0.630
C	9.91	10.66	0.390	0.420
D	3.54	4.08	0.139	0.161
E	5.85	6.85	0.230	0.270
F	2.54	3.18	0.100	0.125
G	1.15	1.65	0.045	0.065
H	2.79	5.84	0.110	0.230
J	0.64	1.01	0.025	0.040
K	2.54	BSC	0.100	BSC
L	5.08	BSC	0.200	BSC
M	4.32	4.82	0.170	0.190
N	1.14	1.39	0.045	0.055
Q	0.35	0.56	0.014	0.022
R	2.29	2.79	0.090	0.110

Dimensions TO-263(D²PAK)



REF.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.70		0.93	0.027		0.037
B2	1.25	1.40		0.048	0.055	
C	0.45		0.60	0.017		0.024
C2	1.21		1.36	0.047		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.28	0.393		0.405
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.40		1.75	0.055		0.069
R		0.40			0.016	
V2	0°		8°	0°		8°

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
I _{T(RMS)}	RMS on-state current (180° conduction angle)		T _c = 105°C	12
I _{T(AV)}	Average on-state current (180° conduction angle)		T _c = 105°C	8
I _{TSM}	Non repetitive surge peak on-state current	tp = 8.3 ms	T _j = 25°C	146
		tp = 10 ms		140
I ² t	I ² t Value for fusing	tp = 10 ms	T _j = 25°C	98
dI/dt	Critical rate of rise of on-state current I _G = 2 x I _{GT} , tr < 100 ns	F = 60 Hz	T _j = 125°C	50
I _{GM}	Peak gate current	tp = 20 μs	T _j = 125°C	4
P _{G(AV)}	Average gate power dissipation		T _j = 125°C	1
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125
				°C
V _{RGM}	Maximum peak reverse gate voltage			5
				V

STYN212(S) thru STYN1012(S)

Thyristor Discretes(SCRs)

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$, unless otherwise specified)

■ STANDARD

Symbol	Test Conditions			Value	Unit
I_{GT}	$V_D = 12 \text{ V}$ $R_L = 33 \text{ W}$	MIN.	2	mA	
V_{GT}		MAX.	15		
V_{GD}		MAX.	1.3		
V_D	$V_D = V_{DRM}$ $R_L = 3.3 \text{ kW}$	$T_j = 125^\circ\text{C}$	MIN.	0.2	V
I_H	$I_T = 500 \text{ mA}$ Gate open		MAX.	30	mA
I_L	$I_G = 1.2 I_{GT}$		MAX.	60	mA
dV/dt	$V_D = 67\% V_{DRM}$ Gate open	$T_j = 125^\circ\text{C}$	MIN.	200	V/ μ s
V_{TM}	$I_{TM} = 24 \text{ A}$ tp = 380 μ s	$T_j = 25^\circ\text{C}$	MAX.	1.6	V
V_{t0}	Threshold voltage	$T_j = 125^\circ\text{C}$	MAX.	0.85	V
R_d	Dynamic resistance	$T_j = 125^\circ\text{C}$	MAX.	30	$\text{m}\Omega$
I_{DRM}	$V_{DRM} = V_{RRM}$	$T_j = 25^\circ\text{C}$	MAX.	5	μA
I_{RRM}		$T_j = 125^\circ\text{C}$		2	mA

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case (DC)	1.3	$^\circ\text{C/W}$
$R_{th(j-a)}$	Junction to ambient $S = 1.0 \text{ cm}^2$	TO-220AB	60
		TO-263	45

S= copper surface under tab

PRODUCT SELECTOR

Part Number	Voltage (xxx)	Sensitivity	Package
STYNX12S	200~1000	15 mA	TO-263
STYNX12	200~1000	15 mA	TO-220AB

OTHER INFORMATION

Part Number	Marking	Weight	Base Quantity	Packing mode
STYNX12S	STYNX12S	1.50 g	50	Tube
STYNX12	STYNX12	1.90 g	50	Tube

Note: x = voltage

